

2SK3843

Switching Regulator, DC/DC Converter and Motor Drive Applications

- Low drain-source ON resistance :  $R_{DS(ON)} = 2.7\text{ m}\Omega$  (typ.)
- High forward transfer admittance :  $|Y_{fs}| = 120\text{ S}$  (typ.)
- Low leakage current :  $I_{DSS} = 10\text{ }\mu\text{A}$  (max) ( $V_{DS} = 40\text{ V}$ )
- Enhancement mode :  $V_{th} = 1.5\sim 3.0\text{ V}$  ( $V_{DS} = 10\text{ V}$ ,  $I_D = 1\text{ mA}$ )

Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	40	V
Drain-gate voltage ( $R_{GS} = 20\text{ k}\Omega$ )		$V_{DGR}$	40	V
Gate-source voltage		$V_{GSS}$	$\pm 20$	V
Drain current	DC (Note 1)	$I_D$	75	A
	Pulse (Note 1)	$I_{DP}$	300	A
Drain power dissipation ( $T_c = 25^\circ\text{C}$ )		$P_D$	125	W
Single-pulse avalanche energy (Note 2)		$E_{AS}$	542	mJ
Avalanche current		$I_{AR}$	75	A
Repetitive avalanche energy (Note 3)		$E_{AR}$	12.5	mJ
Channel temperature		$T_{ch}$	150	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	$-55\sim 150$	$^\circ\text{C}$

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th(ch-c)}$	1.0	$^\circ\text{C/W}$

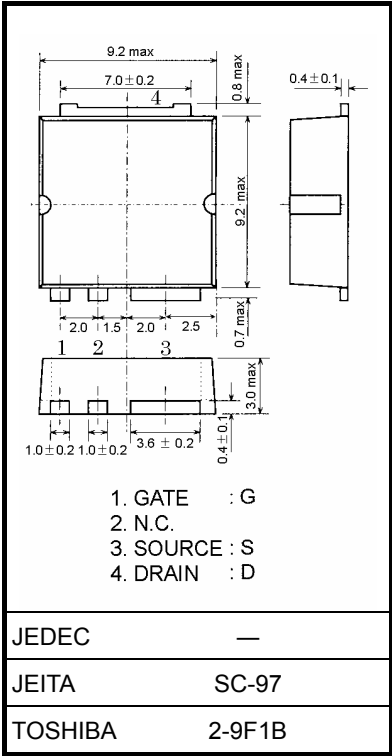
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD} = 25\text{ V}$ ,  $T_{ch} = 25^\circ\text{C}$  (initial),  $L = 100\text{ }\mu\text{H}$ ,  $I_{AR} = 75\text{ A}$ ,  $R_G = 25\text{ }\Omega$

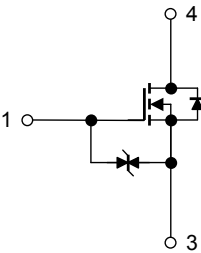
Note 3: Repetitive rating: pulse width limited by maximum channel temperature.

This transistor is an electrostatic-sensitive device. Handle with care.

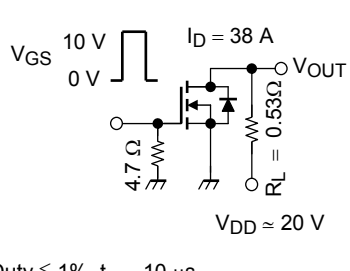
Unit: mm



Weight: 0.74 g (typ.)



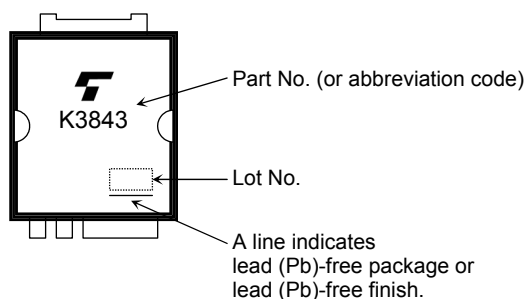
## Electrical Characteristics (Ta = 25°C)

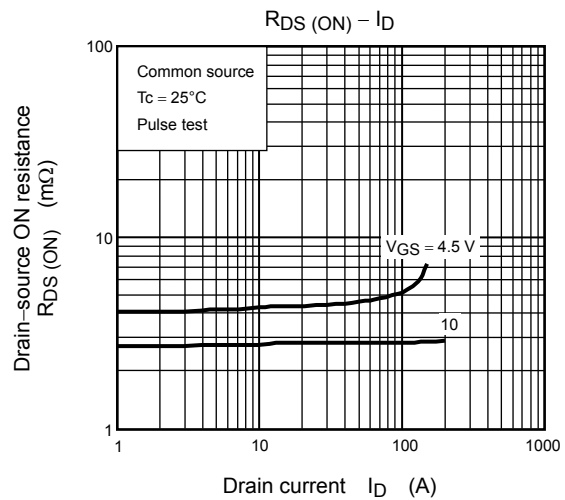
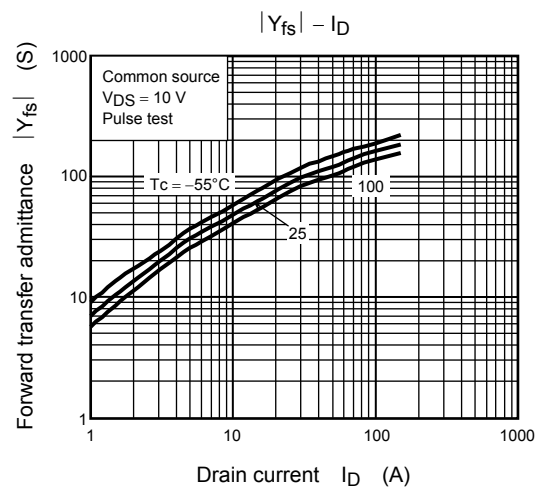
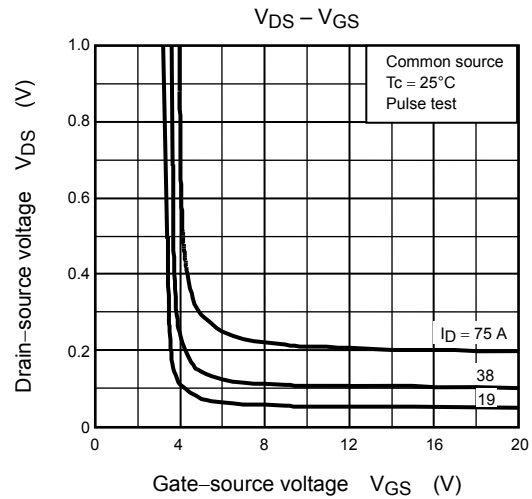
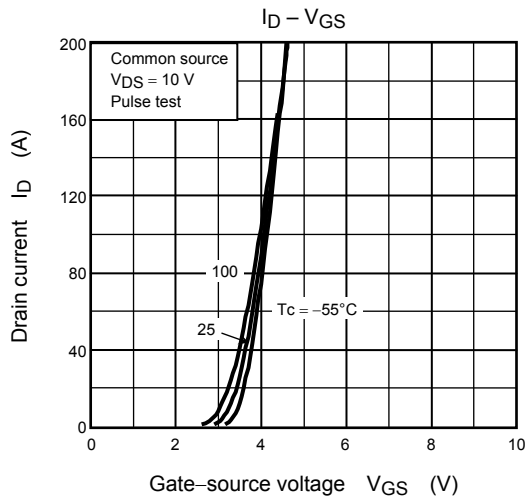
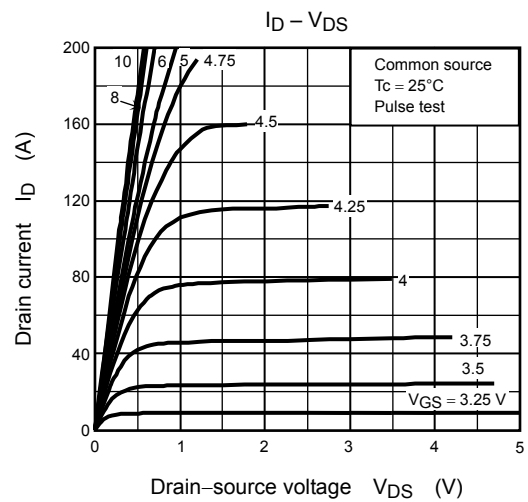
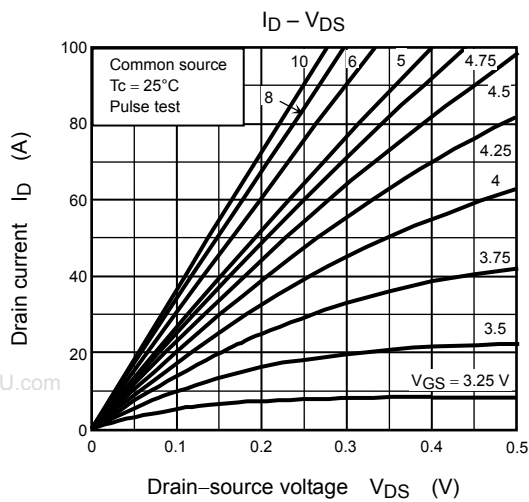
Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I <sub>GSS</sub>	V <sub>GS</sub> = ±16 V, V <sub>DS</sub> = 0 V	—	—	±10	μA
Drain cutoff current		I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V	—	—	10	μA
Drain–source breakdown voltage		V <sub>(BR) DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	40	—	—	V
		V <sub>(BR) DSX</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = –20 V	15	—	—	
Gate threshold voltage		V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.5	—	3.0	V
Drain–source ON resistance		R <sub>DS (ON)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 38 A	—	4.3	8.0	mΩ
			V <sub>GS</sub> = 10 V, I <sub>D</sub> = 38 A	—	2.7	3.5	
Forward transfer admittance		Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 38 A	60	120	—	S
Input capacitance		C <sub>iss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	—	11200	—	pF
Reverse transfer capacitance		C <sub>rss</sub>		—	800	—	
Output capacitance		C <sub>oss</sub>		—	1350	—	
Switching time	Rise time	t <sub>r</sub>		—	12	—	ns
	Turn-on time	t <sub>on</sub>		—	40	—	
	Fall time	t <sub>f</sub>		—	65	—	
	Turn-off time	t <sub>off</sub>		—	260	—	
Total gate charge (gate–source plus gate–drain)		Q <sub>g</sub>	V <sub>DD</sub> ≈ 32 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 75 A	—	210	—	nC
Gate–source charge		Q <sub>gs</sub>		—	150	—	
Gate–drain (“Miller”) Charge		Q <sub>gd</sub>		—	60	—	

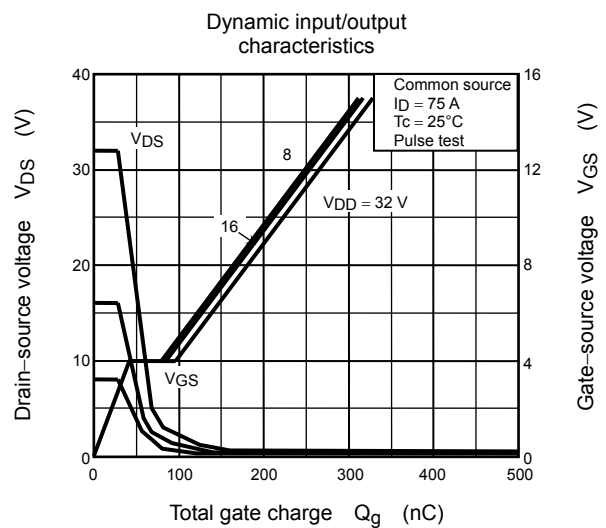
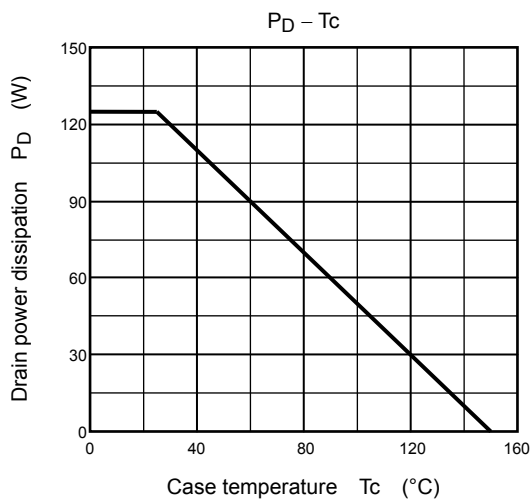
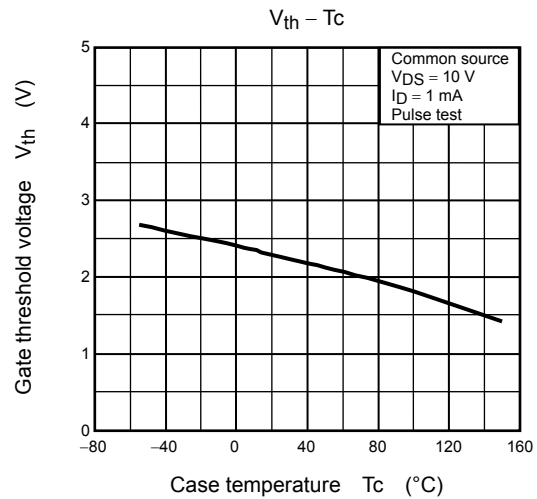
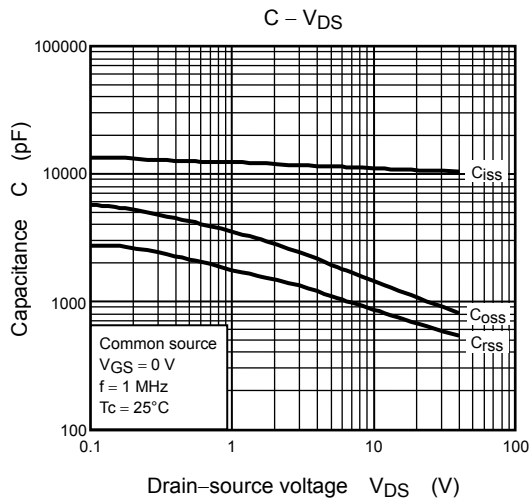
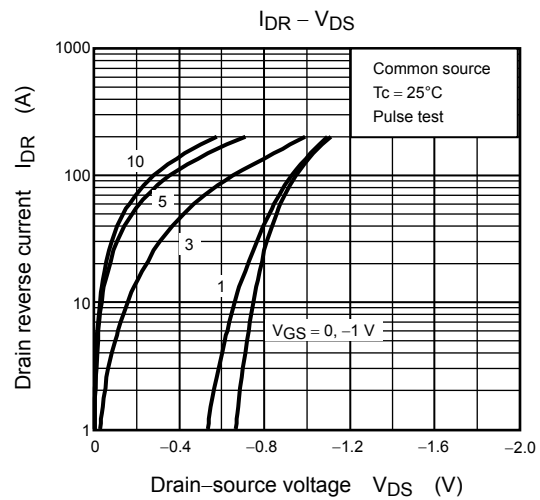
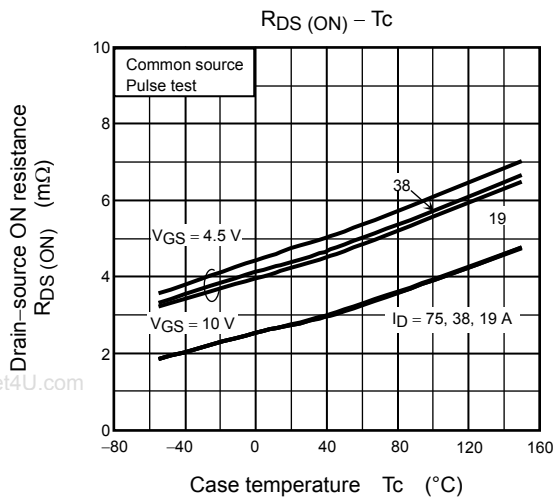
## Source–Drain Ratings and Characteristics (Ta = 25°C)

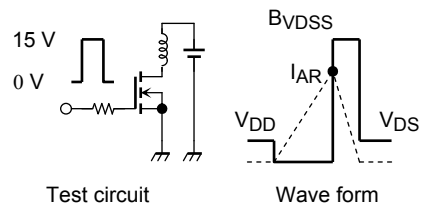
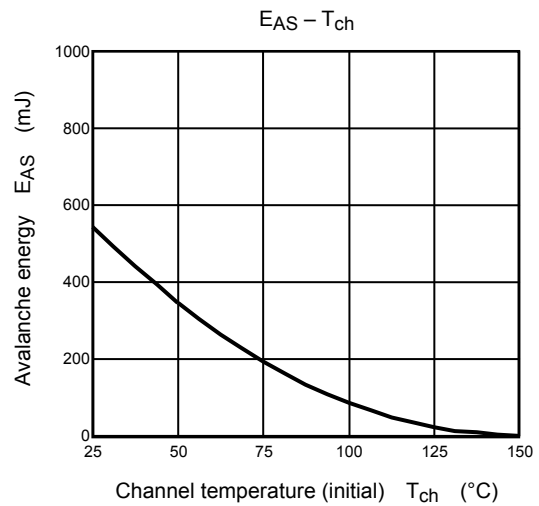
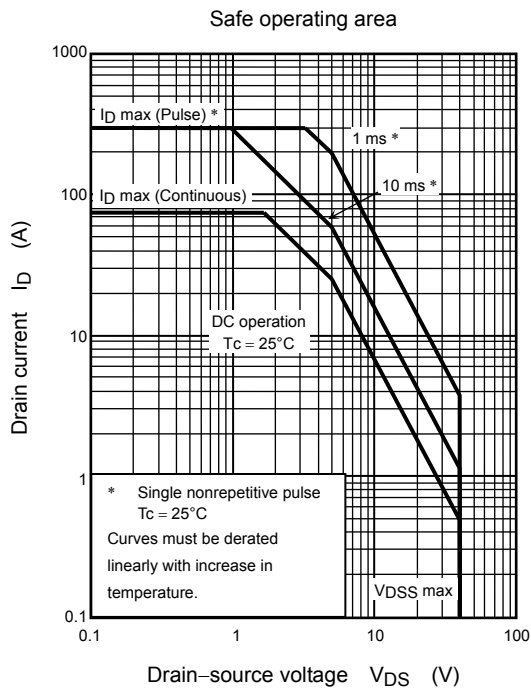
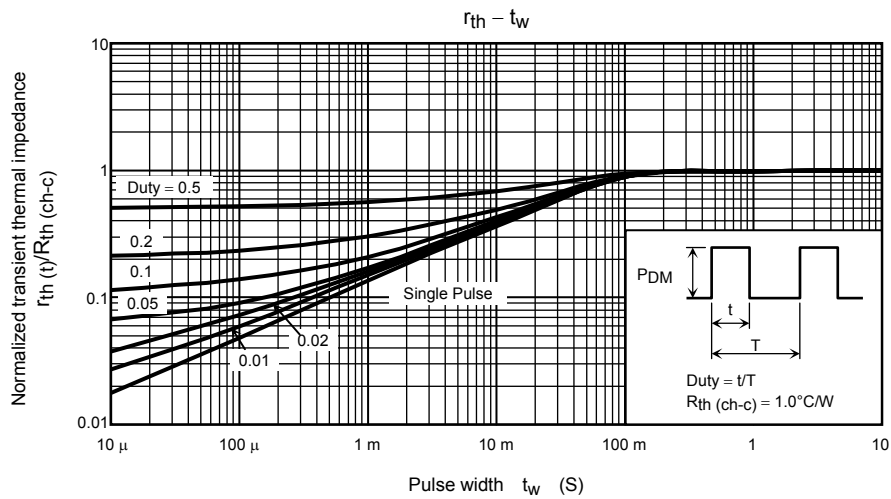
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	$I_{DR}$	—	—	—	75	A
Pulse drain reverse current (Note 1)	$I_{DRP}$	—	—	—	300	A
Forward voltage (diode)	$V_{DSF}$	$I_{DR1} = 75 \text{ A}, V_{GS} = 0 \text{ V}$	—	—	–1.5	V
Reverse recovery time	$t_{rr}$	$I_{DR} = 75 \text{ A}, V_{GS} = 0 \text{ V}$	—	100	—	ns
Reverse recovery charge	$Q_{rr}$	$dI_{DR}/dt = 30 \text{ A}/\mu\text{s}$	—	120	—	nC

## Marking









$$R_G = 25\ \Omega$$

$$V_{DD} = 25\ V, L = 100\ \mu H$$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{BVDSS}{BVDSS - V_{DD}} \right)$$

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